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Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)			
30	0.022 at V _{GS} = 10 V	7.5			
	0.030 at V _{GS} = 4.5 V	6.5			

SCHOTTKY PRODUCT SUMMARY					
V _{DS} (V)	V _{SD} (V) V _{DS} (V) Diode Forward Voltage				
30	0.50 at 1 A	2.0			

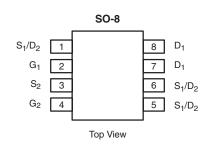
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- LITTLE FOOT[®] Plus Schottky
- Si4830DY Pin Compatible
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



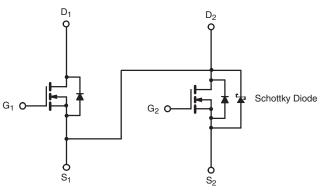
APPLICATIONS

Asymmetrical Buck-Boost DC/DC Converter



Ordering Information: Si4830ADY-T1-E3 (Lead (Pb)-free)

Si4830ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted								
Parameter		Symbol	10 s	Steady State	Unit			
Drain-Source Voltage		V _{DS}	30		V			
Gate-Source Voltage		V_{GS}	± 20		V			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	7.5	5.7				
	T _A = 70 °C		6.0	4.6	Α			
Pulsed Drain Current		I _{DM}	30		A			
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.9				
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	2.0	1.1	W			
	T _A = 70 °C] 'D	1.3	0.7	VV			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C			

THERMAL RESISTANCE RATINGS								
			MOSFET		SCHOTTKY			
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	52	62.5	53	62.5		
	Steady State		93	110	93	110	2014	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	35	40	35	40	°C/W	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

Si4830ADY

Vishay Siliconix



MOSFET SPECIFICATIONS	$T_{\rm J} = 25 ^{\circ}{\rm C}$, unless otherwise noted					
Parameter	Symbol	Test Conditions			Typ. ^a	Max.	Unit
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1.4		3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$				± 100	nA
		V _{DS} = 30 V, V _{GS} = 0 V	Ch-1			1	
Zava Cata Valtaga Drain Current	1		Ch-2			100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _{.1} = 85 °C	Ch-1			15	- μΑ
		V _{DS} = 30 V, V _{GS} = 0 V, I _J = 83 C	Ch-2			2000	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$		20			Α
5	D	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$			0.017	0.022	Ω
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 4.5 V, I _D = -6.5 A			0.024	0.030	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 7.5 \text{ A}$			19		S
h	V _{SD}	I _S = 1 A, V _{GS} = 0 V	Ch-1		0.75	1.2	V
Diode Forward Voltage ^b			Ch-2		0.47	0.5	
Dynamic ^a			-				-
Total Gate Charge	Q_g				7	11	
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 7.5 \text{ A}$			2.9		nC
Gate-Drain Charge	Q _{gd}	1			2.5		1
Gate Resistance	R_{g}			0.5	1.5	2.4	Ω
Turn-On Delay Time	t _{d(on)}				9	15	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 15 \Omega$			10	17	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 1 \text{ A, V}_{GEN} = 10 \text{ V, R}_g = 6 \Omega$			19	30	
Fall Time	t _f	1			9	15	ns
Course Drain Deverse Decease Times	erse Recovery Time t _{rr}	L = 1.7 A dl/dt = 100 ···	Ch-1		35	55	1
Source-Drain Reverse Recovery Time		I _F = 1.7 A, dI/dt = 100 μs	Ch-2		32	55	1

Notes:

b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

SCHOTTKY SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Forward Voltage Drop	V _F	I _F = 1.0 A		0.47	0.50	V		
		I _F = 1.0 A, T _J = 125 °C		0.36	0.42	V		
Maximum Reverse Leakage Current	I _{rm}	V _R = 30 V		0.004	0.100			
		V _R = 30 V, T _J = 100 °C		0.7	10	mA		
		V _R = - 30 V, T _J = 125 °C		3.0	20			
Junction Capacitance	C _T	V _R = 10 V		50		pF		

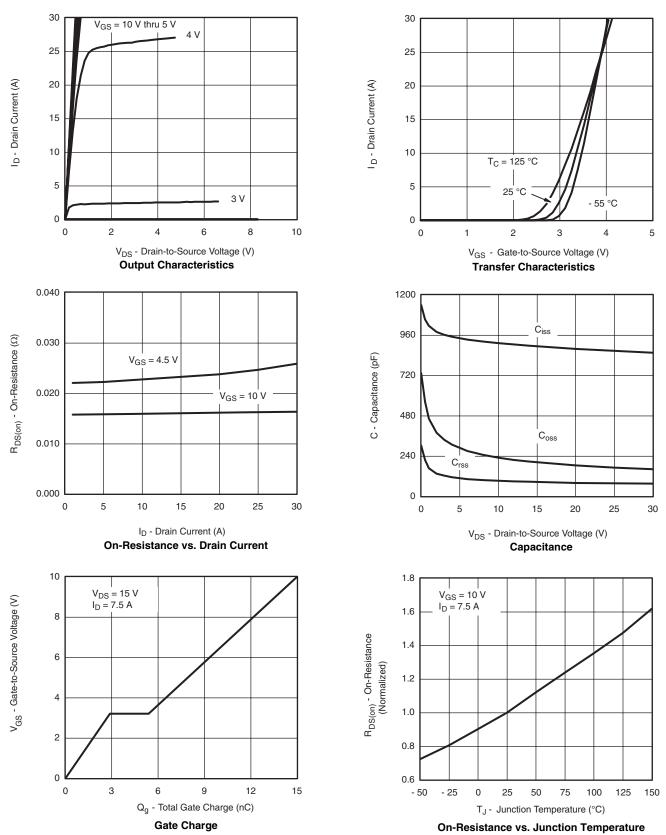
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Guaranteed by design, not subject to production testing.



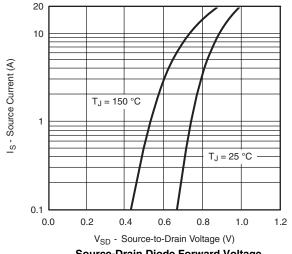


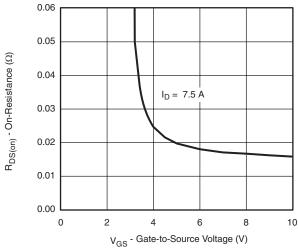
MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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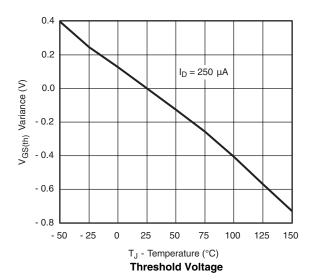
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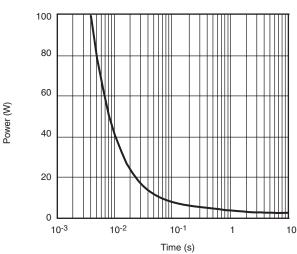




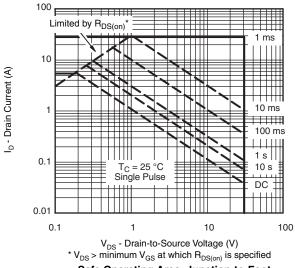
Source-Drain Diode Forward Voltage





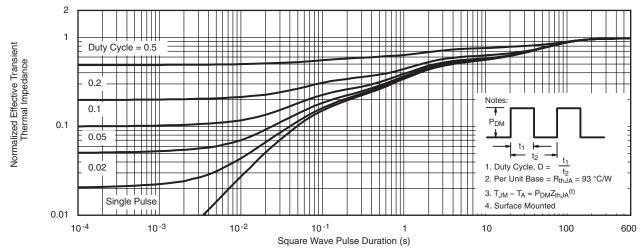


Single Pulse Power, Junction-to-Ambient

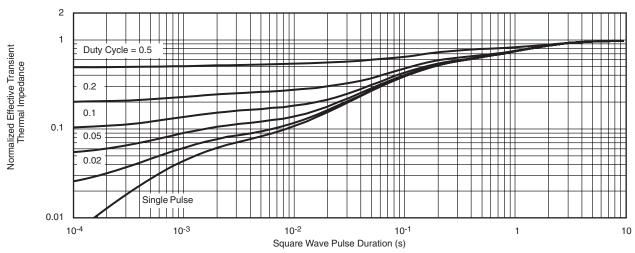




MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

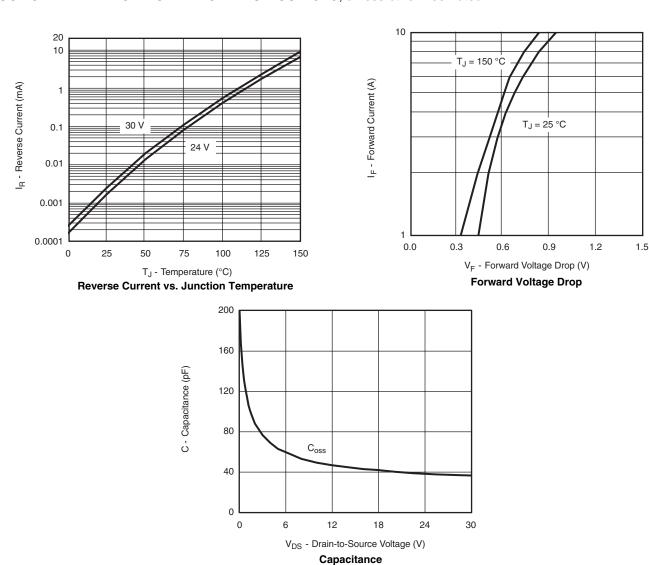


Normalized Thermal Transient Impedance, Junction-to-Foot

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SCHOTTKY TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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